

RA FAMILY

Industry-Leading Arm® Cortex®-M Family,
Delivering the Ultimate Promise of Security,
Connectivity and Intelligent IoT



INTRODUCING THE RA FAMILY

Delivering the Ultimate Promise of IoT with Software Flexibility



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Strong Security

- Secure Crypto Engine (SCE) IP
- An extra level of embedded hardware security providing tamper detection and resistance to side-channel attacks
- Integrated Arm® v8-M TrustZone®



Arm Core

- Based on Arm Cortex-M23/M33 processor cores and Cortex-M4 core



Flexible Software Solution

- Supported by an open and flexible ecosystem concept, the Flexible Software Package (FSP)
- FreeRTOS, Azure RTOS, and BareMetal implementations
- Can be replaced and expanded by any other RTOS or middleware



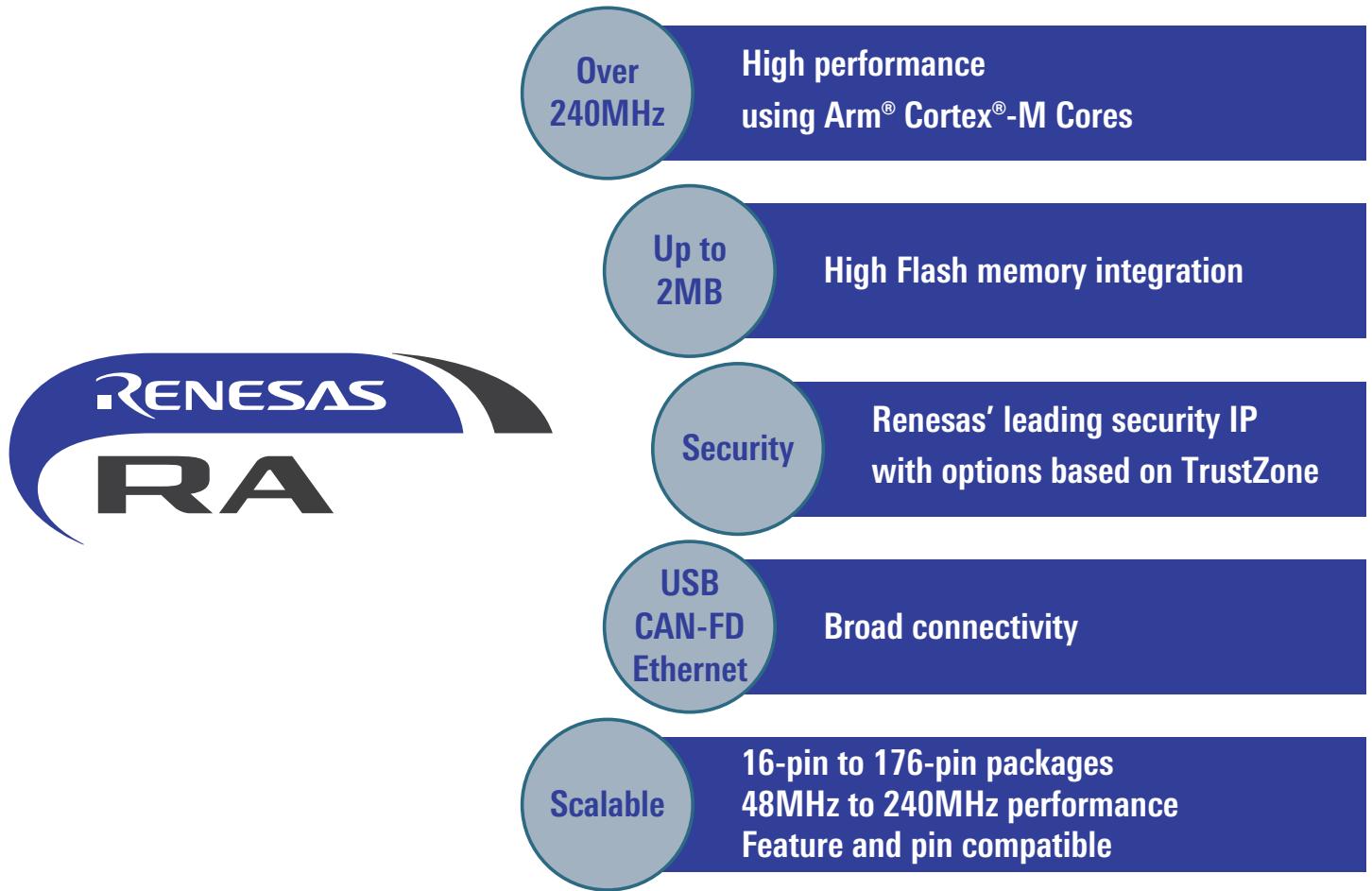
Best-in-Class Peripheral IP

- Excellent HMI capacitive touch technology
- Highest code flash memory capacity in the industry
- Wide range of connectivity solutions

What is the Renesas RA Family?

The flexible Renesas Advanced (RA) 32-bit MCUs are industry leading 32-bit MCUs with the Arm® Cortex®-M33, -M23 and -M4 processor cores and PSA Certified™ assurance. The RA Family delivers key advantages compared to competitive Arm Cortex-M MCUs by providing stronger embedded security, superior CoreMark® performance, and ultra-low power operation. PSA Certified provides customers the confidence and assurance to quickly deploy secure IoT endpoint and edge devices, and smart factory equipment for Industry 4.0.

- Renesas Advanced: Innovative market-leading products based on Arm Cortex-M cores
- Ultimate promise of IoT security by further enhancing Renesas' popular Secure Crypto Engine (SCE) IP
- Best-in-class peripheral IP provided by Renesas
- Easy development of IoT edge applications using the new Flexible Software Package



RA Family Overview

The Renesas RA Family lineup can be separated into four product series. Each of these series has a unique feature set, making it ideal for various applications and market needs.

The RA8 Series is the top-end product series, aiming for the highest integration and the highest performance. The RA8 Series supports operation at CPU speeds over 240 MHz with single or dual core, with the largest Flash and RAM integration to suit applications where performance really matters most.

The RA6 Series offers the widest integration of communication interfaces, with integrated Ethernet and TFT display drivers. Memory densities range from 128KB Flash to 2MB Flash. The RA6 Series offers up to 240MHz performance running on the Cortex-M4 or Cortex-M33 core with TrustZone. The RA6 Series supports full security integration, making these devices widely desired for security applications.

The RA4 Series balances the requirements for low power with the demand for connectivity. It offers up to 1MB Flash and a wide range of communication interfaces. The utilized core is the Cortex-M4 or Cortex-M33 with TrustZone and additional security IP integration. Memory densities range from 128KB Flash up to 1MB Flash. These devices provide a CPU frequency of up to 100MHz.

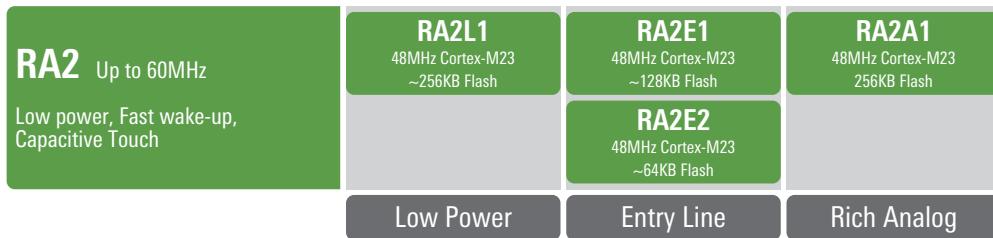
On the lower end is the RA2 Series, where the low power requirements of an application matter most for these device definitions. To achieve the best performance, special power-down modes are provided, making these devices well suited for battery-powered applications. The RA2 Series provides memory densities of up to 256KB embedded Flash and a wide single voltage supply range of 1.6 to 5.5V. These devices use the Cortex-M23 core at up to 48MHz.

Series	Group					
RA8 Over 240MHz Highest Performance, Largest Flash and RAM						
RA6 Up to 240MHz Advanced Performance, Connectivity, Security, Scalability	RA6M3 120MHz Cortex-M4 ~2MB Flash	RA6M5 200MHz Cortex-M33 ~2MB Flash	RA6E1 200MHz Cortex-M33 ~1MB Flash			RA6T2 240MHz Cortex-M33 ~512KB Flash
	RA6M2 120MHz Cortex-M4 ~1MB Flash	RA6M4 200MHz Cortex-M33 ~1MB Flash	RA6E2 200MHz Cortex-M33 ~256KB Flash			RA6T3 200MHz Cortex-M33 256KB Flash
	RA6M1 120MHz Cortex-M4 512KB Flash					RA6T1 120MHz Cortex-M4 512KB Flash
RA4 Up to 100MHz Excellent power/high-performance mix, Security		RA4M3 100MHz Cortex-M33 ~1MB Flash	RA4E1 100MHz Cortex-M33 ~512KB Flash			
	RA4M1 48MHz Cortex-M4 256KB Flash	RA4M2 100MHz Cortex-M33 ~512KB Flash	RA4E2 100MHz Cortex-M33 128KB Flash		RA4W1 48MHz Cortex-M4 512KB Flash	RA4T1 100MHz Cortex-M33 ~256KB Flash
RA2 Up to 60MHz Low power, Fast wake-up, Capacitive Touch		RA2L1 48MHz Cortex-M23 ~256KB Flash	RA2E1 48MHz Cortex-M23 ~128KB Flash	RA2A1 48MHz Cortex-M23 256KB Flash		
			RA2E2 48MHz Cortex-M23 ~64KB Flash			
	Mainstream Line / Low Power	Entry Line	Rich Analog	Wireless	Motor Control	

RA2 Series

The RA2 Series is the RA Family's entry-level 32-bit MCU, offering excellent cost, performance, and ultra-low power consumption. It delivers up to 48MHz of CPU performance using an Arm® Cortex®-M23 core with up to 256KB of embedded flash memory and a wide single voltage supply range from 1.6V to 5.5V. With cutting-edge peripherals like high accuracy analog and capacitive touch sensing, the RA2 Series is ideal for system control or user interface applications such as healthcare devices, home appliances, office equipment, and measuring equipment.

RA2 Series Product Groups



RA2 Series Benefits

- RA2 Series use Arm cortex-M23 core which most compact and efficient Cortex-M implementation based on ARMv8-M architecture profile offering high code density, low gate count, Thumb-2 instruction set, and hardware divide features.
- Large product lineup is from 16 up to 100 pin and Flash memory size starting from 16KB up to 256KB, including some very small package options, including QFN, LGA, BGA and smallest WLCSP
- Best-in class Active/Standy power consumption for Arm® Cortex®-M23 microcontroller
- On-chip analog components include a high accuracy 16-bit ADC, 24-bit sigma-delta ADC, fast response 12-bit DAC, rail-to-rail low-offset operational amplifiers, and high-speed/low-power comparators
- Reduced cost with on-chip peripheral functions, including high precision (1.0%) high-speed oscillator, temperature sensor, 5V tolerant ports and background operation data flash supporting 1 million erase/program cycles
- Enhanced capacitive touch sensing unit (CTSU) with high sensitivity and high noise immunity that realizes intuitive, high-quality HMI designs
- Various communication interfaces such as USB, CAN and I3C, which support IoT applications

Overview of each Product Groups

- RA2L1 Group is Industry leading ultra-low power 32-bit Arm Cortex-M23 MCU. RA2L1 also features an enhanced Capacitive Touch Sensing Unit (CTSU2), a set of serial communication interfaces, highly accurate converters and timers.
- RA2E1 Group is entry level general-purpose MCU. RA2E1 provides pin and peripheral compatibility with the RA2L1 group and is ideal for battery-operated applications and other systems requiring high performance and low-energy consumption.
- RA2E2 Group offers ultra-low power operation and high speed serial communication with smallest package options of 20-pin and 24-pin QFN and 16-pin wafer-level CSP package, satisfying the needs of cost-sensitive and space-constrained applications.
- RA2A1 provides highly integrated, high-accuracy analog capabilities. This group of ICs offers a complete MCU with analog solution for signal conditioning and measurement.

RA4 Series

The RA4 Series bridges the need for reasonable low power with the demand for connectivity and performance. These MCUs deliver up to 100MHz of CPU performance using an Arm® Cortex®-M33 core or M4 core with up to 1MB of embedded flash memory. The series offers a wide set of peripherals, including USB, CAN/CAN FD, I²C, ADC, Bluetooth Low Energy 5.0, capacitive touch, segment LCD controller, and additional security IP integration, making it suitable for IoT, industrial equipment, home appliances, office equipment, healthcare products, and meters.

RA4 Series Product Groups

RA4 Up to 100MHz Excellent power/high-performance mix, Security	RA4M3 100MHz Cortex-M33 ~1MB Flash	RA4E1 100MHz Cortex-M33 ~512KB Flash		
	RA4M1 48MHz Cortex-M4 256KB Flash	RA4M2 100MHz Cortex-M33 ~512KB Flash	RA4E2 100MHz Cortex-M33 128KB Flash	RA4W1 48MHz Cortex-M4 512KB Flash
	Mainstream Line	Entry Line	Wireless	Motor Control

RA4 Series Benefits

- Secure element functionality providing better performance, unlimited secure key storage, key management, and lower BOM cost
- High-performance and low power at the same time with 81µA/MHz while running the CoreMark® algorithm from flash at 100MHz
- High-integration up to 1MB code flash memory with background operation and flash block SWAP operation for flexible and memory optimized firmware updates, 8KB data flash memory, and 128KB SRAM with Parity/ECC
- Rich connectivity with Bluetooth 5.0, USB 2.0 Full-Speed, CAN/CAN FD, SDHI, QSPI, I²C, I³C, HDMI-CEC, and advanced analog
- Wide range of compact BGA packages available for applications where space is at a premium

Overview of each Product Groups

- RA4M1 Group uses the high-performance 48 MHz Arm® Cortex®-M4 core and offers a segment LCD controller and a capacitive touch sensing unit input for applications such as user interfaces and meters where low power along with a large number of capacitive touch channels and a segment LCD controller are required.
- RA4M2 group uses a high-performance 100 MHz Arm® Cortex®-M33 core with TrustZone along with an advanced secure crypto engine, offering the features of a secure element on-chip and the ability to secure your application. The RA4M2 is suitable for IoT applications requiring multiple communication channels with support for USB, CAN and QSPI as well as multiple channels of I²C and SCI, a large embedded SRAM, and low active power consumption.
- RA4M3 group uses the high-performance 100 MHz Arm® Cortex®-M33 core with TrustZone along with an advanced secure crypto engine, and support for applications that require large on-chip Flash and SRAM. The RA4M3 security engine offering the features of a secure element on-chip and Trustzone allows you to secure your application. The RA4M3 is suitable for IoT applications requiring multiple communication channels with support for USB, CAN and QSPI as well as multiple channels of I²C and SCI, and low active power consumption.
- RA4E1 group uses the high-performance 100 MHz Arm® Cortex®-M33 core with TrustZone and supports large on-chip Flash and SRAM. The RA4E1 has been developed to support entry IoT applications requiring a value optimized feature set, total system cost reduction and an optimized mixture of high performance and lowest active power consumption while still offering a wide range of connectivity features.
- RA4E2 Group offers high-performance and optimized peripheral functions along with the smallest package options including space saving 36-pin BGA and 32-pin QFN packages. These satisfy the needs of both cost-sensitive and space-constrained applications.
- RA4T1 Group offers optimized peripheral functions for motor control and inverter control with small 32-pin QFN and LQFP package options. These satisfy the needs of high-performance, cost-sensitive and spaceconstrained applications.

RA6 Series

The RA6 Series offers the widest integration of communication interfaces as well as the best performance level. These MCUs aim for up to 240MHz of CPU performance using an Arm® Cortex®-M4 or M33 core and a memory range from 128KB to 2MB Flash. The series offers Ethernet, USB Full Speed and High Speed, QSPI, OctaSPI, CAN/CAN FD, I²C, and TFT display driver integration. The embedded security engines are full of features you can leverage in your higher-level solutions with secure element services. The RA6 Series addresses a broad range of applications for IoT endpoints such as white goods, meters, and other industrial and consumer applications.

RA6 Series Product Groups

RA6 Up to 240MHz Advanced Performance, Connectivity, Security, Scalability	RA6M3 120MHz Cortex-M4 ~2MB Flash	RA6M5 200MHz Cortex-M33 ~2MB Flash	RA6E1 200MHz Cortex-M33 ~1MB Flash	RA6T2 240MHz Cortex-M33 ~512KB Flash
	RA6M2 120MHz Cortex-M4 ~1MB Flash	RA6M4 200MHz Cortex-M33 ~1MB Flash	RA6E2 200MHz Cortex-M33 ~256KB Flash	RA6T3 200MHz Cortex-M33 256KB Flash
	RA6M1 120MHz Cortex-M4 512KB Flash			RA6T1 120MHz Cortex-M4 512KB Flash
		Mainstream Line	Entry Line	Motor Control

RA6 Series Benefits

- Secure element functionality providing better performance, unlimited secure key storage, key management, and lower BOM cost
- High-performance and low-power with 80µA/MHz while running the CoreMark® algorithm from flash at 200MHz
- High-integration up to 2MB code flash memory with background operation, Dual-bank, and flash block SWAP operation for extremely flexible and memory optimized firmware updates, 8KB Data flash memory, and 512KB SRAM with Parity/ECC
- Rich connectivity with Ethernet MAC controller, CAN FD, USB 2.0 High-Speed and Full-Speed, SDHI, Quad and Octa SPI, I²C, I³C, HDMI-CEC, and advanced analog with three sample and hold per ADC, PGA and high-speed comparators
- Wide range of compact BGA packages available for applications where space is at a premium

Overview of each Product Groups

- RA6M1 group uses a high-performance, 120 MHz Arm® Cortex®-M4 core optimised to provide an attractive price for cost sensitive applications. The RA6M1 is suitable for IoT applications requiring security, large, embedded SRAM and low power consumption. With support for a wide range of connectivity requirements including USB, CAN, QSPI and SDHI as well as multiple channels of SCI, SPI and I²C.
- RA6M2 uses a high-performance, 120 MHz Arm® Cortex®-M4 core and offers Ethernet MAC with individual DMA, to ensure high data throughput along with advanced security functions and a wide range of other connectivity features such as USB and QSPI, as well as multiple channels of CAN, SDHI, SCI, SPI and I²C. The RA6M2 is suitable for IoT applications requiring Ethernet, security, large, embedded SRAM, and low active power consumption.
- RA6M3 uses a high-performance, 120 MHz Arm® Cortex®-M4 core and offers a TFT controller with 2D accelerator and JPEG decoder. Additionally, the RA6M3 MCU offers Ethernet MAC with individual DMA and USB high-speed interface to ensure high data throughput along with a wide range of other connectivity features as well as advanced security functions. The RA6M3 is suitable for IoT applications requiring TFT, Ethernet, security, large, embedded SRAM, and USB High Speed (HS).
- RA6M4 uses a high-performance, 200 MHz Arm® Cortex®-M33 core with TrustZone along with an advanced secure crypto engine, offering the features of a secure element on-chip and the ability to secure your application. The RA6M4 includes an integrated Ethernet MAC with individual DMA ensures high data throughput along with a wide range of other connectivity options including USB, CAN, SDHI, QSPI and OctaSPI. The RA6M4 is suitable for IoT applications requiring Ethernet, advanced security, large embedded SRAM, and low active power consumption.
- RA6M5 uses a high-performance, 200 MHz Arm® Cortex®-M33 core with TrustZone® along with an advanced secure crypto engine, offering the features of

a secure element on-chip and the ability to secure your application. The RA6M5 offers large on-chip memories with up to 2 Mbytes of on-chip Flash and 512 Kbytes of SRAM, it also includes a wide range of connectivity functionality including an integrated Ethernet MAC with individual DMA ensures high data throughput along with a wide range of other connectivity options including USB, CAN, SDHI, QSPI and OctaSPI. The RA6M5 is suitable for IoT applications requiring Ethernet, advanced security, large embedded memories and low active power consumption.

- RA6E1 uses a high-performance, 200 MHz Arm® Cortex®-M33 core with TrustZone and provides the perfect, cost effective entry point into the RA Family of microcontrollers. The RA6E1 is suitable for entry IoT applications requiring streamlined feature and connectivity integration including Ethernet and large on-chip memories, and provides unprecedented performance with 790.75 CoreMark, which are 3.95CoreMark / MHz.
- RA6E2 Group offers best-in-class performance as an entry-line microcontroller while pursuing cost optimization. Pin and peripheral compatibility with the RA4E2 group makes it ideal for applications requiring higher performance, small footprint, and lower pin counts.
- RA6T1 Group combines an Arm Cortex®-M4 at 120MHz and a rich peripheral function for motor such as PWM timer, high-speed 12-bit ADC, PGA, comparator. It can also control up to two brushless DC motors with one chip.
- RA6T2 combines an Arm Cortex®-M33 with a hardware accelerator for motor control and high-speed flash memory for high-speed real-time performance at 240MHz. It can also realize high-speed, high-response motor algorithms and improve parallel processing performance such as other communication processing.
- RA6T3 is pin and function compatible with the RA4T1 group and can be seamlessly upgraded, making it an ideal solution for motor control and inverter control applications requiring higher performance.

Target Applications and Markets

The Renesas RA Family targets various application fields. Due to its scalability, the RA Family offers parts which cover many different applications and customer needs.

The feature set of the Renesas RA Family is well suited for industrial applications due to its long product life with 105° Celsius support. Dedicated analog feature integration like ADC, PGA, and comparators, combined with powerful and flexible timers, makes the RA Family an ideal fit for motor control applications.

Features like connectivity peripherals, hardware-accelerated cryptography, and scalability make the whole RA Family a perfect fit for customers who want to design secure and connected products in areas such as building or industrial automation.

Customers with Electricity Metering applications will enjoy the scalability and long product life of the RA Family, in addition to the on-chip security engines.

The integrated Capacitive Touch interface, combined with the scalability of the RA Family, make the RA Family an ideal fit for white goods applications, enabling innovative HMI designs.

	Best Suitable Product Series			Application Examples	
Industrial Automation		Renesas RA2 Series	Renesas RA4 Series	Renesas RA6 Series	<ul style="list-style-type: none"> ▪ Robotics ▪ Door Openers ▪ AC Drive ▪ AC Servo ▪ UPS ▪ Functional Safety
Building Automation		Renesas RA2 Series	Renesas RA4 Series	Renesas RA6 Series	<ul style="list-style-type: none"> ▪ Fire Panels ▪ HVAC ▪ Boiler Control ▪ Vending Machines ▪ Motion Detection ▪ Monitoring Systems
Metering		Renesas RA2 Series	Renesas RA4 Series	Renesas RA6 Series	<ul style="list-style-type: none"> ▪ Electricity Meters ▪ Automated Meter Reading ▪ Network Cards ▪ Flow Meters ▪ Power Meters
Home Appliance		Renesas RA2 Series	Renesas RA4 Series	Renesas RA6 Series	<ul style="list-style-type: none"> ▪ HVAC ▪ Air Cleaners ▪ Coffee Machines ▪ Vacuum Cleaners ▪ Cleaning Robots ▪ White Goods
Connectivity		Renesas RA2 Series	Renesas RA4 Series	Renesas RA6 Series	<ul style="list-style-type: none"> ▪ AS15 / IO-Link Gateways ▪ Communication Gateways ▪ Data Concentrators ▪ Wired Ethernet ▪ Fleet Tracking
Security		Renesas RA4 Series	Renesas RA6 Series		<ul style="list-style-type: none"> ▪ Fire Detectors ▪ Burglar Detection ▪ Panel Control ▪ Door Openers ▪ Monitoring Systems ▪ Access Control
Motor Control		Renesas RA4 Series	Renesas RA6 Series		<ul style="list-style-type: none"> ▪ Brushless DC Motors ▪ Induction Motors ▪ Stepper Motors ▪ Magnetic Encoders ▪ Optical Encoders ▪ Hall Sensors
Low Power		Renesas RA2 Series	Renesas RA4 Series		<ul style="list-style-type: none"> ▪ IO-Link Sensors ▪ Heat Cost Allocators ▪ Portable Audio Devices ▪ Smoke Detectors ▪ IoT Sensing Nodes ▪ Wearable Devices
HMI		Renesas RA2 Series	Renesas RA6 Series		<ul style="list-style-type: none"> ▪ Voice Recognition ▪ Capacitive Touch Panels ▪ Printers ▪ Vending Machines ▪ Home Appliances ▪ Medical Equipment
Wireless		Renesas RA4 Series			<ul style="list-style-type: none"> ▪ Wearable Devices ▪ Healthcare ▪ Panel Control ▪ Gateway Units ▪ Door Openers ▪ Smart Home

Integrated Hardware-based Security

In the rapidly growing area of IoT and highly-connected devices, increasing consumer awareness and government legislation is forcing embedded device manufacturers to take the topic of security seriously. Already under the constraints of needing to create cost- and energy-efficient solutions, developers nowadays are required to design and implement security with limited additional time and budget.

The RA Family was designed with security in mind and scalable hardware-based security features including:

- Isolated cryptographic operations with integrated security engines
- Unlimited secure key storage
- Hardware-enforced isolation using Arm® TrustZone® technology
- Side-channel protections

The Flexible Software Package provides integrated, easy-to-configure support for these features, and a collection of Application Projects enables you to easily incorporate them into your design.

The RA Family has achieved the following certifications, providing assurance of these security capabilities and giving you confidence in your product's security.

- PSA Certified Level 1 and Level 2
- SESIP
- NIST CAVP



IEC61508 Functional Safety Solution

The importance of functional safety is increasing in order to prevent hazards and risks to people, machinery, and the environment from failure or error at the manufacturing site. However, designing the system and being certified under functional safety standards such as IEC 61508 requires a great deal of effort and time, which increases cost and could delay the product release significantly compared to non-safe development.

Renesas offers a one-stop functional safety solution comprised of general-purpose 32-bit microcontrollers (MCUs) with software solution components.



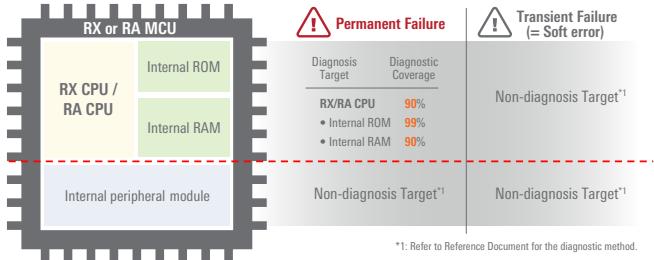
Solution Introduction

The Self-Test Software Kit provides a self-diagnostics software library for microcontroller, a complete safety manual, user guide and IEC61508 SIL3 Certificate test report certified by TÜV Rheinland Industrie Service GmbH (Germany). For safe system development, developers can use the information they require from the safety manual and make use of the self-diagnostics software library to alleviate the burden on microcontroller-level development to conform to functional safety.



This Kit diagnoses the permanent failure of CPU, internal ROM, and internal RAM.

* Please refer to the reference document for permanent failure diagnosis of other modules and transient failure diagnosis.



*1: Refer to Reference Document for the diagnostic method.

Target Application

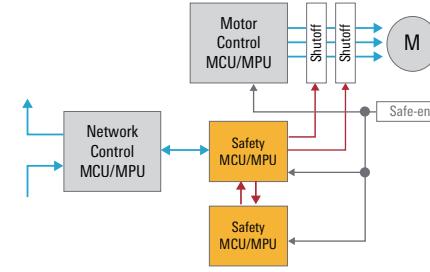
Safety System for:

- AC Servo & Drive
- Remote IO
- Programmable Logic Controller
- Sensor and Actuator

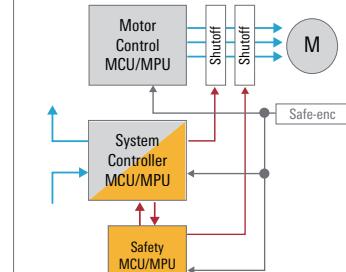


Target Safety System Example (Motor Control + Network Control + Safety)

Example 1



Example 2



IEC 60730 Safety Classes Support



The IEC/UL 60730 is the harmonized safety standard for household appliances.

It describes requirements for automatic controls including heating and air-conditioning applications. Renesas offers for the RA Family a self-test library to fulfill Class B requirements of the IEC 60730 standard, as this is the most commonly used requirement.

The related Appendix H lists all the specific faults that must be tested and details the need to place the equipment into a safe state for any single point failure.

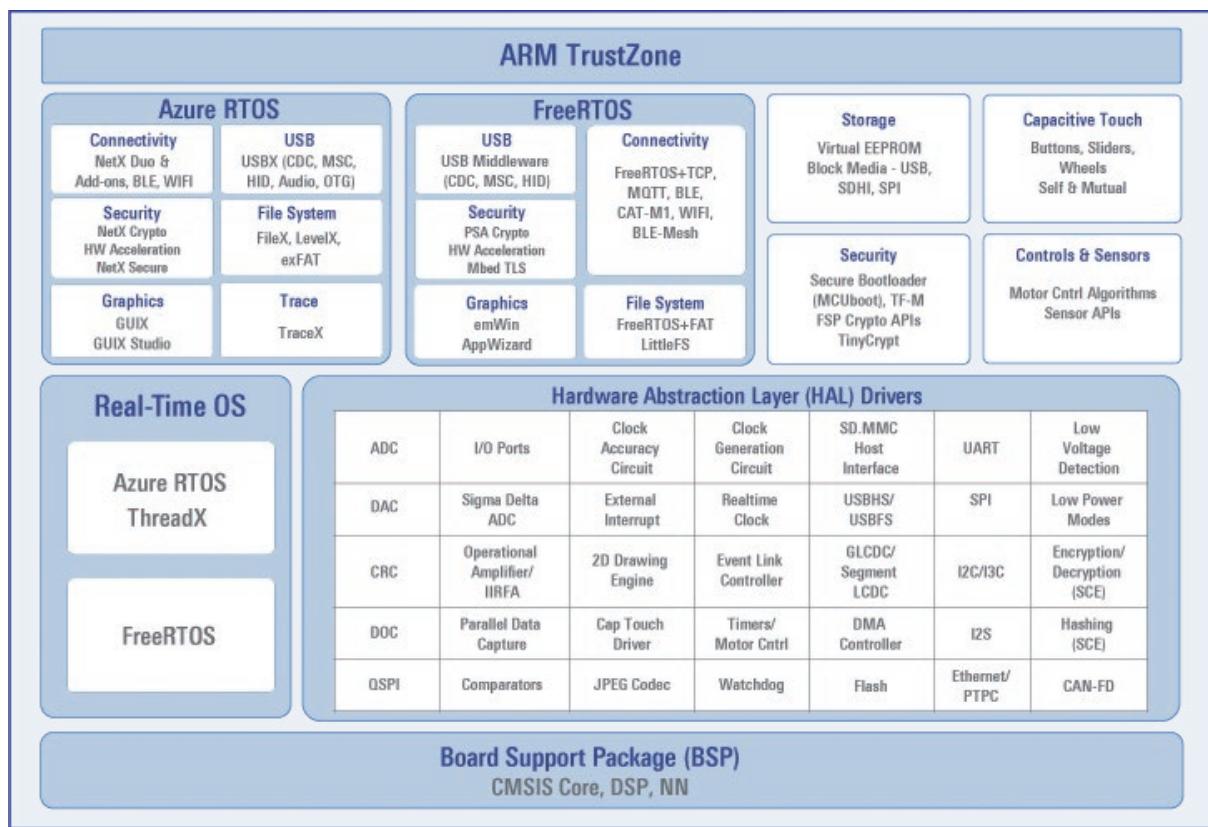
In response to the need of designing IEC/UL 60730 certified applications, Renesas provides an RA Family IEC 60730 Self-Test Library designed to reduce the burden on customers developing their own solutions. The package comes with the sample code and the certification done by VDE.

Flexible Software Package

The Renesas Flexible Software Package (FSP) is an enhanced software package designed to provide easy-to-use, scalable, high-quality software for embedded system designs using Renesas RA Family Microcontrollers. With the support of new Arm® TrustZone® and other advanced security features, FSP provides a quick and versatile way to build secure, connected IoT devices using production-ready drivers, Azure® RTOS, FreeRTOS™, and other middleware stacks.

FSP uses an open software ecosystem and provides flexibility in using bare-metal programming, included Azure RTOS or FreeRTOS, your preferred RTOS, legacy code, and third-party ecosystem solutions.

The combination of the flexible open architecture of the FSP plus the wide choice of 3rd party solutions as part of the Arm ecosystem increases the range of choice for application development. This means that developers can choose the software model that best suits their needs while utilizing Renesas's excellent Arm-based silicon solutions as well as speed up the implementation time of complex areas like connectivity and security.



Benefits

- Provides an easy-to-use, scalable, high-quality software for embedded system designs using the Renesas RA Family of Arm microcontrollers
- Includes best-in-class HAL drivers with high performance and low memory footprint
- Middleware stacks with Azure RTOS and FreeRTOS integration are included to ease the implementation of complex modules like communication and security
- The e² studio IDE provides support with intuitive configurators and intelligent code generation to make programming and debugging easier and faster
- Uses an open software ecosystem and provides flexibility in using bare-metal programming, included Azure RTOS and FreeRTOS, your preferred RTOS, legacy code, and third-party ecosystem solutions
- Integrated package with all required components for easy setup and starting development (single installer with e² studio, CMSIS packs, tool chain and SEGGER J-Link drivers)
- Complete source code available through GitHub

Development Environment

The RA family development environment offers flexibility in terms of different supported on-chip debuggers, IDEs, and compilers. Customers can use the Renesas e² studio, Keil MDK and IAR Embedded Workbench. All tools can use the RA configurators for FSP driver and middleware selection and configuration, in addition to pin mapping and clock tree configuration.

Overview

	Renesas e ² studio	IAR Systems Embedded Workbench for Arm	Keil Microcontroller Development Kit
Compilers	<ul style="list-style-type: none"> - GCC - Arm Compiler * - IAR Arm Compiler * 	<ul style="list-style-type: none"> - IAR Arm Compiler * 	<ul style="list-style-type: none"> - Arm Compiler *
Debugger probes	<ul style="list-style-type: none"> - Renesas E2/E2 Lite - SEGGER J-Link 	<ul style="list-style-type: none"> - SEGGER J-Link - IAR I-Jet (limited support) 	<ul style="list-style-type: none"> - SEGGER J-Link - Keil ULINK (limited support)
Smart Configurator	<ul style="list-style-type: none"> Built-in - BSP - Clock - Pin - Drivers - Interrupts 	<ul style="list-style-type: none"> Supplied as RASC - BSP - Clock - Pin - Drivers - Interrupts 	<ul style="list-style-type: none"> Supplied as RASC - BSP - Clock - Pin - Drivers - Interrupts
Application specific configurator	<ul style="list-style-type: none"> - QE for Capacitive Touch - QE for BLE - QE for AFE - Motor Control Workbench 	NA	NA

*: Compiler must be purchased and licensed directly from 3rd-party.

Benefits

The eclipse-based e² studio along with a GCC compiler and SEGGER J-Link debugger is the primary development solution for RA MCUs and Flexible Software Package (FSP). e² studio offers a complete development flow from initial project generators, graphical FSP configuration and comprehensive debugger options.

As the RA MCU family includes TrustZone-enabled devices, new configuration options ensure that a development engineer can concentrate on the application rather than the underlying technology.

Renesas recognizes that Arm based MCUs benefit from a wide ecosystem, so we have worked with Keil and IAR Systems to develop the RA Smart Configurator (RASC) that inherits all the FSP configurator options from e² studio to extend the rich development options into the MDK and EWARM IDEs. To complement the powerful SEGGER J-Link probes, RA MCUs have been ported to the Renesas E2 and E2 Lite debuggers.

Production programming options are available from Renesas (RFP and PG-FP6) in addition to numerous 3rd-party solutions such as SEGGER Flasher. Please contact your preferred partner to request RA production device programing support.

RA Microcontroller Kits

Effortless Innovation Made Possible

The RA microcontroller kits enable users to effortlessly evaluate the features of different RA MCU Groups & develop sophisticated IoT & embedded systems applications. The kits are based on a novel architecture that provides an unparalleled combination of standardization & flexibility. The kit design helps users shorten the learning curve & accelerate development, providing more time for differentiated innovation or taking products to market faster. Users can utilize rich on-board features along with their choice of popular ecosystem add-ons to bring their big ideas to life.



Innovation Ready

A winning combination of standardization & flexibility that enables shorter learning curve & faster time to market



Ecosystem Ready

Enhance functionality on your terms & choose from hundreds of 3rd-party add-ons from popular ecosystems



World Ready

Compliant with many international standards. Documentation available in English & Japanese



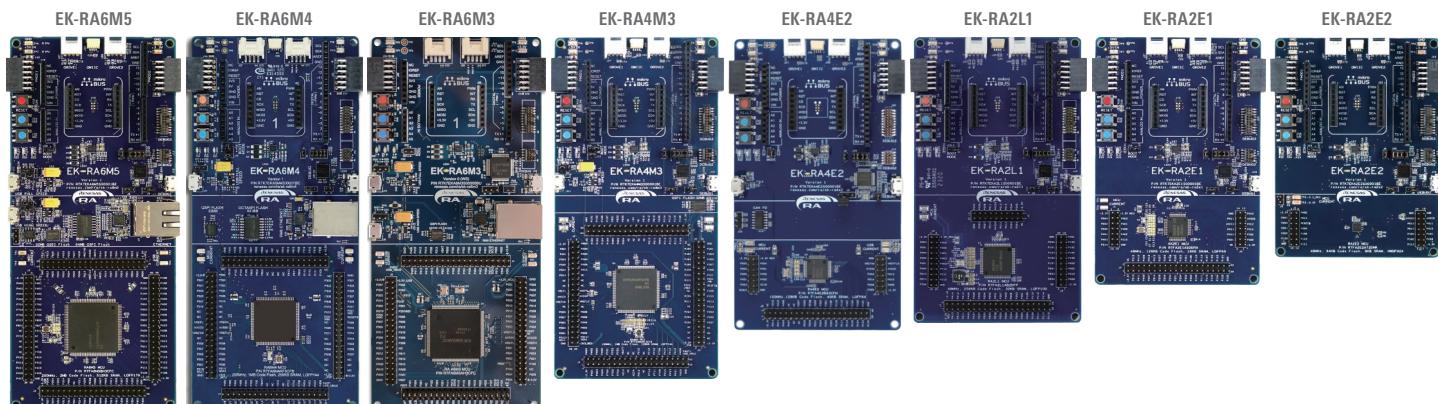
Fun Ready

Take the guesswork out of your innovation experience for an unmatched, systematic & methodical approach to start developing

Differentiation that Sets You Apart

The RA microcontroller kits portfolio consists of a variety of kits to suit many use cases such as functional evaluation, getting started reference, prototyping, proof-of-concepts, solutions demo, research & academia.

RA Kits Portfolio	RA6 MCU Series	RA4 MCU Series	RA2 MCU Series
General-purpose kits <ul style="list-style-type: none"> ■ Differentiated functionality ■ Remarkable ease of use ■ Broad ecosystem compatibility ■ Multiple debugging modes ■ Feature scalability & expansion across RA MCU series: RA6, RA4 & RA2 ■ Basic MCU pin access ■ Limited ecosystem compatibility ■ Basic on-board debugging ■ Design reuse across Renesas MCU families: RA, RX, RL78 & Synergy 	EK-RA6M5 EK-RA6M4 EK-RA6M3 EK-RA6M3G EK-RA6E2 EK-RA6M2 EK-RA6M1 FPB-RA6E1 FPB-RA6E2	EK-RA4M3 EK-RA4M2 EK-RA4E2 EK-RA4M1 EK-RA4W1 FPB-RA4E1 FPB-RA4E2	EK-RA2E2 EK-RA2E1 EK-RA2L1 EK-RA2A1 FPB-RA2E1 FPB-RA2E2
Application-specific kits <ul style="list-style-type: none"> ■ References for specific end-applications 	CK-RA6M5 Cloud MCK-RA6T3 Motor MCK-RA6T2 Motor RSSK-RA6T1 Motor RSSK-RA6M2 Touch VOICE-RA6E1 VUI	MCK-RA4T1 Motor VOICE-RA4E1 VUI	RSSK-RA2L1 Touch VOICE-RA2L1 VUI
3rd-Party/Partner kits <ul style="list-style-type: none"> ■ Access to partner's ecosystem & tools 	M13-RA6M3-EK	RA4M1 Clicker	-



Examples of RA Microcontroller Kits

Learn more: renesas.com/ra/kits

Motor Control Solution

RA Motor Control Development Kits are development kits that enables easy evaluation of motor control using permanent magnet synchronous motors (brushless DC motors). These kits are configured to run the application note sample code that can be downloaded from the homepage. In addition, development support tools such as Renesas Motor Workbench, which can analyze and tune motors, and QE for Motor are available, so you can immediately start evaluating motor control using the RA-T series.

Features

- The CPU board is equipped with the RA-T series devices as the motor control MCU.
- Inverter board for 3-phase BLDC motor
- Supports 3-shunt current sensing
- Overcurrent detection
- Supports Motor Control Development Support Tool Renesas Motor Workbench



MCK-RA6T2 (RTK0EMA270S00020BJ)

	RA6T1	RA6T2	RA6T3	RA4T1
Motor control evaluation Kits	RSSK-RA6T1 (RTK0EMA170S00020BJ)	MCK-RA6T2 (RTK0EMA270S00020BJ)	MCK-RA6T3 (RTK0EMA330S00020BJ)	MCK-RA4T1 (RTK0EMA430S00020BJ)
Included items	RA6T1 CPU card Inverter board (RTK0EM0000B10020BJ) Permanent magnet synchronous motor Accessories (cables, standoffs, etc.)	RA6T2 CPU board Inverter board (MCI-LV-1) Communication board (MC-COM) Permanent magnet synchronous motor Accessories (cables, standoffs, etc.)	RA6T3 CPU board Inverter board (MCI-LV-1) Permanent magnet synchronous motor Accessories (cables, standoffs, etc.)	RA4T1 CPU board Inverter board (MCI-LV-1) Permanent magnet synchronous motor Accessories (cables, standoffs, etc.)

Capacitive Touch Sensing Solution

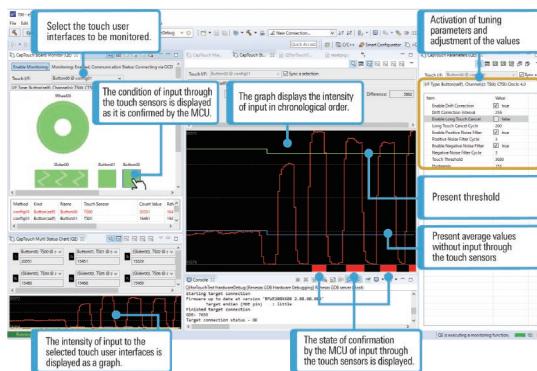
Renesas offers revolutionary design to switching devices and equipment with our 2nd generation capacitive touch solution that enables a user-friendly environment to support manufacturing processes and lowers hurdles in capacitive touch sensor development.

QE for Capacitive Touch is a solution toolkit that runs in the e² studio integrated development environment. It speeds up the development of integrated systems utilizing capacitive touch sensors by simplifying tasks such as configuring initial settings or tuning the sensitivity of the touch interface.

The capacitive touch evaluation system includes a CPU board and a self-capacitance evaluation board for use as a touch application board. It has everything you'll need to get started evaluating applications incorporating buttons, sliders, and wheels.

QE for Capacitive Touch: Development Assistance Tool for Capacitive Touch Sensors

Monitoring and parameter adjustment functions



Capacitive Touch Evaluation System for RA6M2



For more information, visit <https://www.renesas.com/rssk-touch-ra6m2>

Capacitive Touch Evaluation System for RA2L1



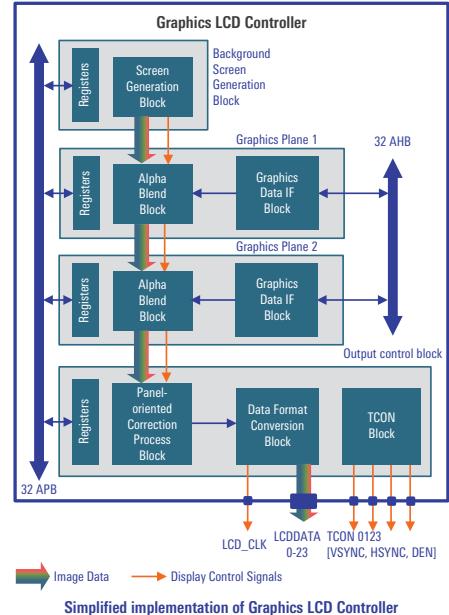
For more information, visit <https://www.renesas.com/rssk-touch-ra2l1>

Graphics Solution

Renesas offers rich graphics solutions that address demanding HMI requirements in diverse application areas. The graphics solutions include the RA MCU hardware, comprehensive graphics software and tools, and a rich set of ecosystem partner solutions.

The RA6M3 MCU supports a rich set of graphics peripherals including a graphics LCD controller with RGB parallel interface that offloads the main CPU and drives a variety of TFT LCD displays, 2D drawing engine, JPEG codec and on-chip and off-chip memory for storage of graphics assets and frame buffers. Together with easy-to-use graphics APIs and the AppWizard GUI tools, it enables development of sophisticated graphics applications.

The EK-RA6M3 Evaluation Kits enable users to seamlessly evaluate the features of the RA6M3 MCUs and develop embedded systems applications using Renesas' Flexible Software Package (FSP) and e² studio IDE. The EK-RA6M3 kits consists of the EK board featuring the RA6M3 MCU with on-chip graphics LCD controller and the graphics expansion board featuring a 4.3-inch TFT color LCD with capacitive touch overlay.



Endpoint AI/ML Solution

Optimized Performance and Scalability

- Renesas RA family MCUs excel in low power consumption and high performance, making them ideal for energy-efficient TinyML applications. The RA family offers a wide range of MCUs, ensuring scalability and seamless migration across different projects.



Support for a Wide Range of ML Tools

- EAI translator that provides efficient conversion from a variety of ML frameworks into C/C++.
- Reality AI's end-to-end cloud tool streamlines the ML development process from data acquisition to deployment.
- Compatibility with open-source inference software such as TensorFlow Lite for microcontrollers.

Advanced Security Features

- RA family MCUs come with the latest integrated security features ensuring data privacy and protecting TinyML applications from potential cyber threats.

Cutting-Edge TinyML Solutions with Industry-Leading Partners

- Easily integrate vision AI like person detection from PlumerAI, person authentication with AlZIP, and enhance interactions using local voice triggers powered by Cyberon.
- Elevate projects with seamless, production-grade solutions.

RA Family Partners

Renesas is enabling a comprehensive partner ecosystem to deliver an array of software and hardware building blocks that will work out-of-the-box with [Renesas RA Family MCUs](#). The Renesas RA ecosystem will help accelerate the development of IoT applications, including core technologies such as security, safety, connectivity, and HMI among others.



Expansive Third Party Solutions Portfolio

- 200+ partners, 300+ solutions and growing
- Coverage across all key IoT technologies
- Robust GTM and strong digital drumbeat

Commercial Grade Building Block Solutions

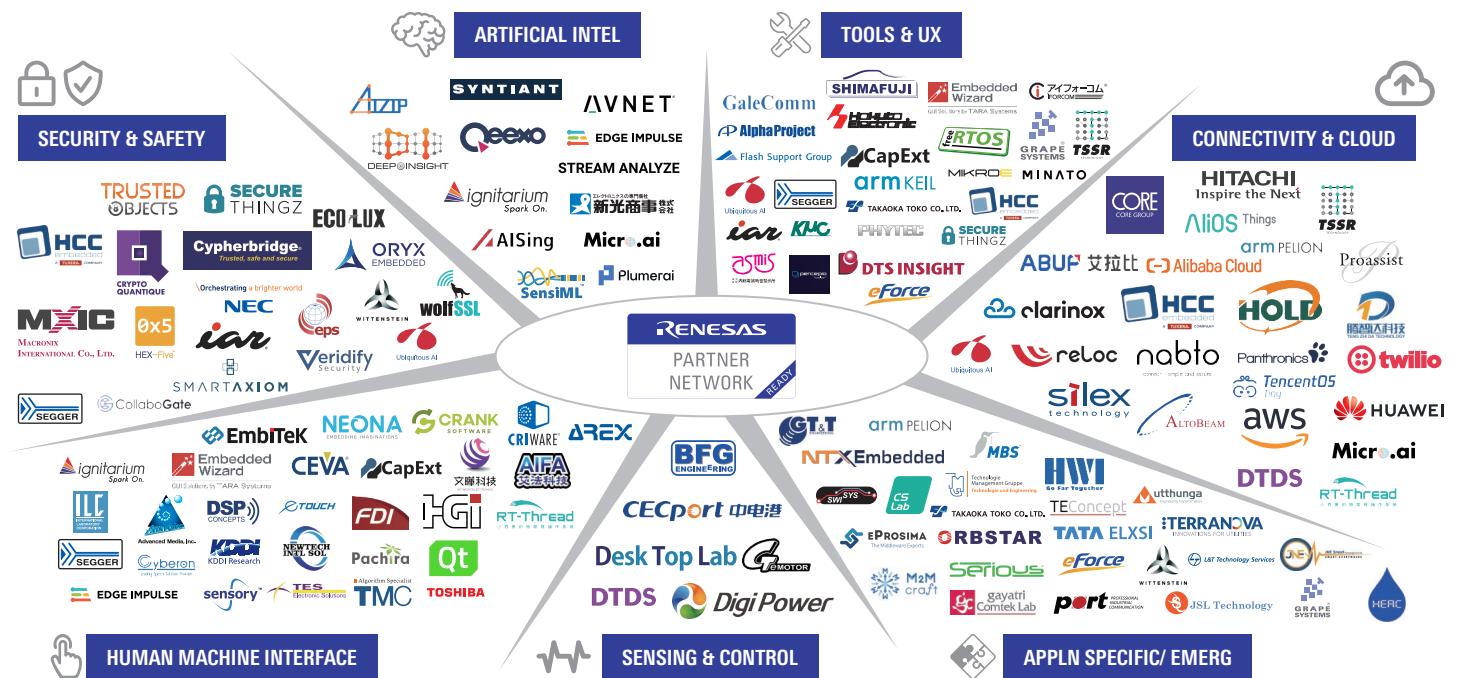
- Commercial grade software
- Work out-of-box with Renesas products
- Bundling options for select solutions

Problem Solving at Heart

- Address specific design problems
- Address specific skill-set gaps
- Customer-centric approach

Partner Overview

The partner overview shown might not be complete since the partner network is extending almost daily. For best reference and latest data, we recommend checking our webpage at: www.renesas.com/ra-partners



MEMO

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SALES OFFICES

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Renesas Electronics Corporation

TOYOSU FORESIS, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan

Renesas Electronics America Inc. Milpitas Campus

1001 Murphy Ranch Road, Milpitas, CA 95035, U.S.A.

Tel: +1-408-432-8888, Fax: +1-408-434-5351

Renesas Electronics America Inc. San Jose Campus

6024 Silver Creek Valley Road, San Jose, CA 95138, USA

Tel: +1-408-284-8200, Fax: +1-408-284-2775

Renesas Electronics Canada Limited

603 March Road, Ottawa, ON K2K 2M5, Canada

Tel: +1-613-595-6300, Fax: +1-613-595-6329

Renesas Electronics Europe GmbH

Arcadienstrasse 10, 40472 Düsseldorf, Germany

Tel: +49-211-6503-0, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.

Room 101-T01, Floor 1, Building 7, Yard No. 7, 8th Street, Shangdi, Haidian District, Beijing 100085, China

Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.

Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai 200333, China

Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited

Unit 3501-03, 35/F, One Kowloon, 1 Wang Yuen Street, Kowloon Bay, Hong Kong
 Tel: +852-2265-6688, Fax: +852 2886-9022

Renesas Electronics Taiwan Co., Ltd.

13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan
 Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.

80 Bendemeer Road, #06-02 Singapore 339949
 Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.

Unit No 3A-1 Level 3A Tower 8 UOA Business Park, No 1 Jalan Pengaturcara U1/51A, Seksyen U1, 40150 Shah Alam, Selangor, Malaysia
 Tel: +60-3-5022-1288, Fax: +60-3-5022-1290

Renesas Electronics India Pvt. Ltd.

Bagmane Tech Park, Municipal No. 66/1-4, Lakeview Block, Block B, Ground Floor, Krishnappa Garden, C V Raman Nagar, Bengaluru, Karnataka 560 093, India
 Tel: +91-80-67208700

Renesas Electronics Korea Co., Ltd.

7F, Hae-seong 2nd building, 508, Teheran-ro, Gangnam-gu, Seoul, Korea 06178
 Tel: +82-2-558-3737, Fax: +82-2-558-5338